

NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V _{CC}	50V
I _{C(MAX.)}	100mA
R ₁	100kΩ
R ₂	100kΩ

Features

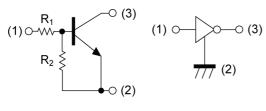
- 1) Built-In Biasing Resistors, $R_1 = R_2 = 100 \text{k}\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA115E series

Application

INVERTER, INTERFACE, DRIVER

•Inner circuit

DTC115EM/ DTC115EEB/ DTC115EUB

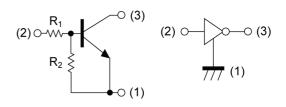


- (1) IN (BASE)
- (2) GND (EMITTER)
- (3) OUT (COLLECTOR)

Outline

- Outilite	
SOT-723	SOT-416FL
(1)	(1) (2)
DTC115EM	DTC115EEB
(VMT3)	(EMT3F)
SOT-416	SOT-323FL
DTC115EE	DTC115EUB
(EMT3)	(UMT3F)
SOT-323	SOT-346
(2)	(2)
DTC115EUA	DTC115EKA
(UMT3)	(SMT3)

DTC115EE/ DTC115EUA/ DTC115EKA



- (1) GND (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC115EM	SOT-723	1212	T2L	180	8	8000	29
DTC115EEB	SOT-416FL	1616	TL	180	8	3000	29
DTC115EE	SOT-416	1616	TL	180	8	3000	29
DTC115EUB	SOT-323FL	2021	TL	180	8	3000	29
DTC115EUA	SOT-323	2021	T106	180	8	3000	29
DTC115EKA	SOT-346	2928	T146	180	8	3000	29

● **Absolute maximum ratings** (T_a = 25°C)

Parameter			Values	Unit
Supply voltage			50	V
Input voltage		V _{IN}	-10 to 40	V
Output current		Io	20	mA
Collector current			100	mA
	DTC115EM		150	mW
	DTC115EEB		150	
Davies dia in eties	DTC115EE	P_{D}^{*2}	150	
Power dissipation	DTC115EUB	P _D -	200	
	DTC115EUA		200	
	DTC115EKA		200	
Junction temperature		T _j	150	°C
Range of storage temperatu	re	T _{stg}	-55 to +150	°C

• Electrical characteristics $(T_a = 25^{\circ}C)$

Danamatan	O	O and this area		Values		1.1:4	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
lanut valtaga	$V_{l(off)}$	$V_{CC} = 5V, I_{O} = 100 \mu A$	-	-	0.5	V	
Input voltage	V _{I(on)}	V _O = 0.3V, I _O = 1mA	3.0	-	-		
Output voltage	V _{O(on)}	I _O = 5mA, I _I = 0.25mA	-	100	300	mV	
Input current	I _I	V _I = 5V	-	-	150	μA	
Output current	I _{O(off)}	V _{CC} = 50V, V _I = 0V	-	-	500	nA	
DC current gain	G _I	$V_{O} = 5V, I_{O} = 5mA$	82	-	-	-	
Input resistance	R ₁	-	70	100	130	kΩ	
Resistance ratio	R ₂ /R ₁	-	0.8	1.0	1.2	-	
Transition frequency	f _T *1	V _{CE} = 10V, I _E = -5mA, f = 100MHz	-	250	-	MHz	

^{*1} Characteristics of built-in transistor

^{*2} Each terminal mounted on a reference land

● Electrical characteristic curves (T_a =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

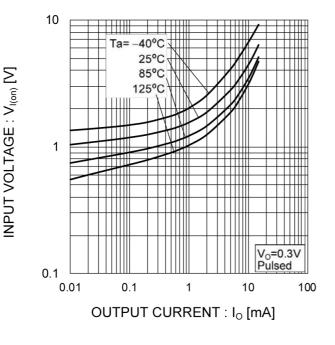


Fig.2 Output current vs. input voltage (OFF characteristics)

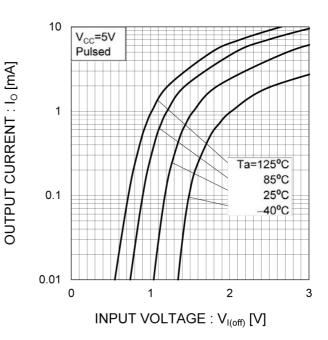


Fig.3 Output current vs. output voltage

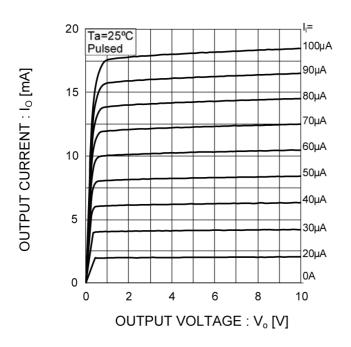
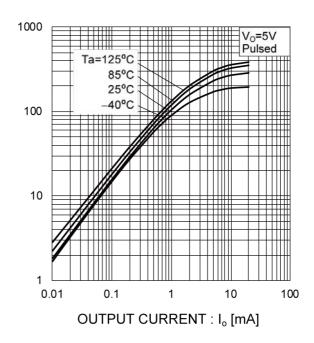


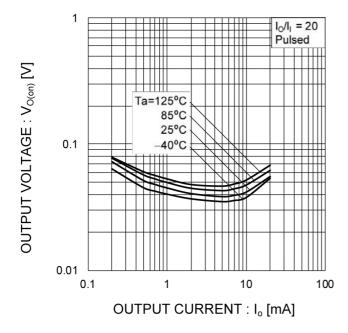
Fig.4 DC current gain vs. output current

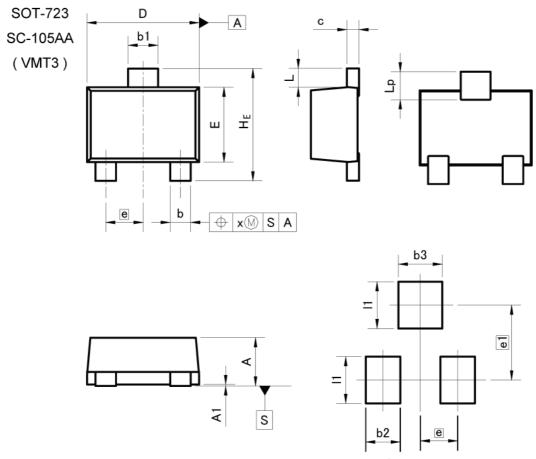


DC CURRENT GAIN: G

●Electrical characteristic curves (T_a =25°C)

Fig.5 Output voltage vs. output current





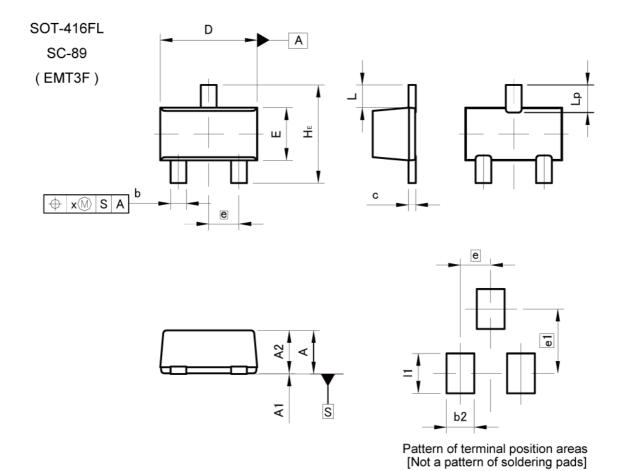
Pattern of terminal position areas
[Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.02	
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	#	0.10	<u> </u>	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	<u> </u>	0.37	544	0.015
b3	223	0.47	822	0.019
e1	0.	80	0.0	031
11	5 98	0.50	250	0.020

Dimension in mm/inches



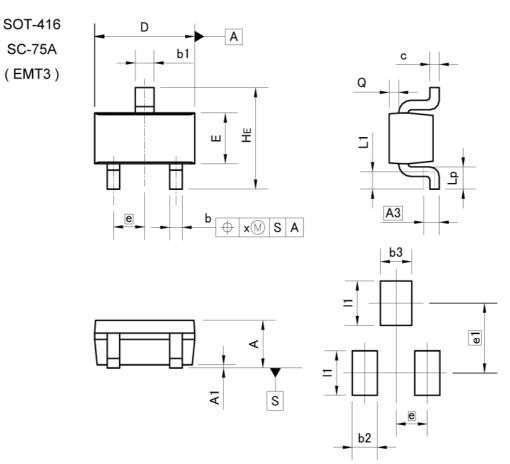


DIM -	MILIM	ETERS	INC	HES
DIM L	MIN	MAX	MIN	MAX
Α	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.9	50	0.020	
HE	1.50	1.70	0.059	0.067
L	0.3	37	0.0	15
Lp	0.35	0.55	0.014	0.022
х		0.10	-	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	= 1	0.46	_	0.018
e1	4:	1.05	-	0.041
11	=	0.65	=	0.026

Dimension in mm/inches





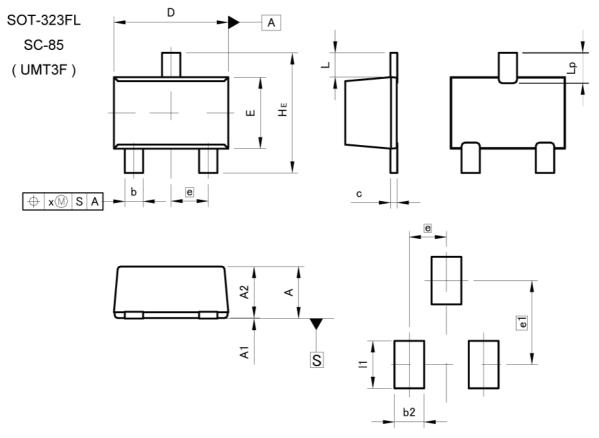
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM [MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.0	20
HE	1.40	1.80	0.055	0.071
L1	0.10	<u>≠</u> 3	0.004	8 11
Lp	0.15		0.006	255
Q	0.05	0.25	0.002	0.010
х	9.7	0.10		0.004

DIM	MILIMETERS		INC	HES
DIM L	MIN	MAX	MIN	MAX
b2	244	0.40	-	0.016
b3	10 48	0.50	; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; 	0.020
e1	1.	1.10		043
11	-	0.70	-	0.028

Dimension in mm/inches





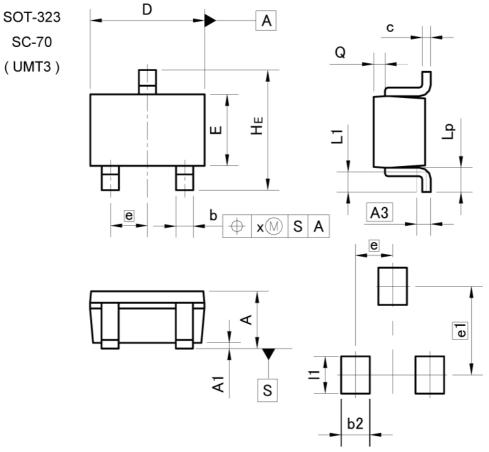
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.026	
HE	2.00	2.20	0.079	0.087
L	0.425		0.017	
Lp	0.43	0.63	0.017	0.025
х		0.10	: :	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	- s	0.52	-	0.020
e1	1.47		0.058	
11	 k	0.83	-	0.033

Dimension in mm/inches





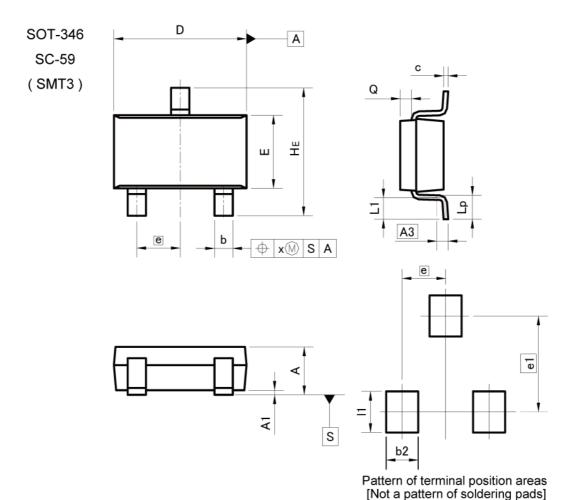
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.026	
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	-	0.10	-	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	<u>644</u> 9	0.50	<u>~=</u>	0.020
e1	1.55		0.061	
11	-	0.65	1000	0.026

Dimension in mm/inches





MILIMETERS INCHES DIM MIN MIN MAX 1.00 1.30 0.039 0.051 0.00 A1 0.10 0.000 0.004 0.25 0.010 A3 0.35 0.50 0.014 0.020 b C 0.09 0.25 0.004 0.010 D 2.80 3.00 0.110 0.118 Ε 1.50 1.80 0.059 0.071 0.95 е 0.037 HE 2.60 3.00 0.102 0.118 L1 0.30 0.60 0.012 0.024 Lp 0.70 0.016 0.028 0.40 Q 0.008 0.012 0.20 0.30 0.004 X 0.10

DIM	MILIMETERS		INCHES	
DIW	MIN	MAX	MIN	MAX
b2	-2	0.60	× -	0.024
e1	2.10		0.083	
11		0.90		0.035

0.10

Dimension in mm/inches

У



0.004

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JAPAN	USA	EU	CHINA
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CLASSIV	CLASSIII	CLASSIII	CLASSIII

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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Notice-PGA-E Rev.003

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Rev.001

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NSBC114YF3T5G NSBC123TF3T5G SMUN5235T1G SMUN5330DW1T1G SSVMUN5312DW1T2G RN1303(TE85L,F)

RN4605(TE85L,F) TTEPROTOTYPE79 DDTC114EUAQ-7-F EMH15T2R SMUN2214T3G NSBC114TF3T5G NSBC143ZPDP6T5G

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NSVDTA114EET1G 2SC2223-T1B-A 2SC3912-TB-E SMUN5237DW1T1G SMUN5213DW1T1G SMUN5114DW1T1G SMUN2111T1G

NSVDTC144EM3T5G DTC124ECA-TP DTC123TM3T5G DTA114ECA-TP DTA113EM3T5G DCX115EK-7-F DTC113EM3T5G

NSVMUN5135DW1T1G NSVMUN2237T1G NSVDTC143ZM3T5G